

Features

- RoHS compliant*
- ESD protection >25 kV
- Low capacitance <0.5 pF
- Low leakage current <50 nA

Applications

- Antenna protection
- Memory / SIM card protection
- HDMI / DVI port protection
- USB 2.0 / IEEE1394 port protection

ChipGuard® MLC Series - ESD Protectors

General Information

The ChipGuard® MLC Series has been specifically designed to protect sensitive electronic components from electrostatic discharge damage. The MLC family has been designed to protect equipment to IEC61000-4-2, Level 4 (±8 kV Contact / ±15 kV Air Discharge) ESD specifications targeted for high speed USB 2.0, HDMI, DVI or IEEE1394 applications.

The ChipGuard® MLC Series has been manufactured to provide low 0.5 pF capacitance and leakage currents less than 50 nA with excellent clamp qualities, making the family almost transparent under normal working conditions.

Device Symbol



Electrical Characteristics @ 25 °C (unless otherwise noted)

Parameter	Symbol	CG0402MLC-						CG0603MLC-								Unit
		3.3LG	05LG	12LG	3.3LGA	05LGA	12LGA	3.3LE	05E	05LE	12E	12LE	3.3LEA	05LEA	12LEA	
Typical Continuous Operating Voltage	V _{DC}	3.3	5	12	3.3	5	12	3.3	5	5	12	12	3.3	5	12	V
Typical Clamping Voltage (Note 1)	V _C	25	25	25	25	25	25	25	20	25	30	25	25	25	25	V
Maximum Capacitance @ 1V _{RMS} 1MHz	C _O	0.5														pF
Maximum Leakage Current @ Max. V _{DC}	I _L	5	5	5	5	5	5	5	50	5	50	5	5	5	5	nA
Typical Trigger Voltage (Note 2)	V _T	250	250	250	250	250	250	250	150	250	150	250	250	250	250	V
Maximum Response Time	R _T	1														nS
ESD Protection: Per IEC 61000-4-2 Level 4 Min. Contact Discharge Min. Air Discharge Min. Air Discharge		±8 (100 Reps Min.) ±15 (100 Reps Min., See Note 3) ±25 (100 Reps Min.)														kV kV kV
Operating Temperature	T _{OPR}	-40 to +85			-40 to +125			-40 to +85				-40 to +125				°C
Storage Temperature	T _{STG}	-55 to +150														°C

Notes: 1. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement 30 ns after initiation of pulse.
 2. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement at maximum pulse voltage.
 3. Some shifting in characteristics may occur when tested over several hundred ESD pulses.

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex.

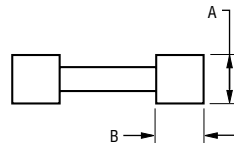
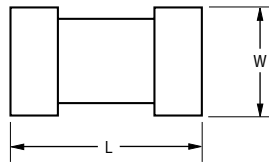
Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

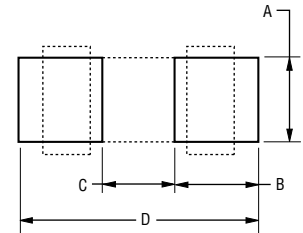
ChipGuard® MLC Series - ESD Protectors

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Product Dimensions



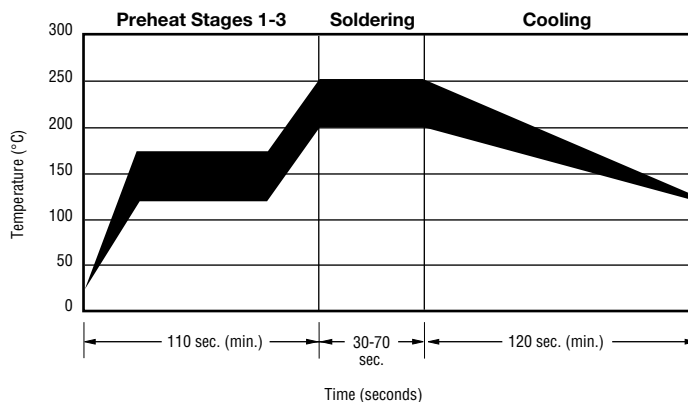
$$\text{DIMENSIONS} = \frac{\text{MM}}{(\text{INCHES})}$$



Dimension	CG0402 Series	CG0603 Series
L	$\frac{1.00 \pm 0.15}{(0.04 \pm 0.006)}$	$\frac{1.60 \pm 0.20}{(0.064 \pm 0.008)}$
W	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
A	$\frac{0.36 \pm 0.05}{(0.014 \pm 0.002)}$	$\frac{0.45 \pm 0.10}{(0.018 \pm 0.004)}$
B	$\frac{0.25 \pm 0.15}{(0.10 \pm 0.006)}$	$\frac{0.30 \pm 0.20}{(0.012 \pm 0.008)}$

Dim.	CG0402 Series	CG0603 Series
A	$\frac{0.51}{(0.020)}$	$\frac{0.76}{(0.030)}$
B	$\frac{0.61}{(0.024)}$	$\frac{1.02}{(0.040)}$
C	$\frac{0.51}{(0.020)}$	$\frac{0.50}{(0.020)}$
D	$\frac{1.70}{(0.067)}$	$\frac{2.54}{(0.100)}$

Solder Reflow Recommendations



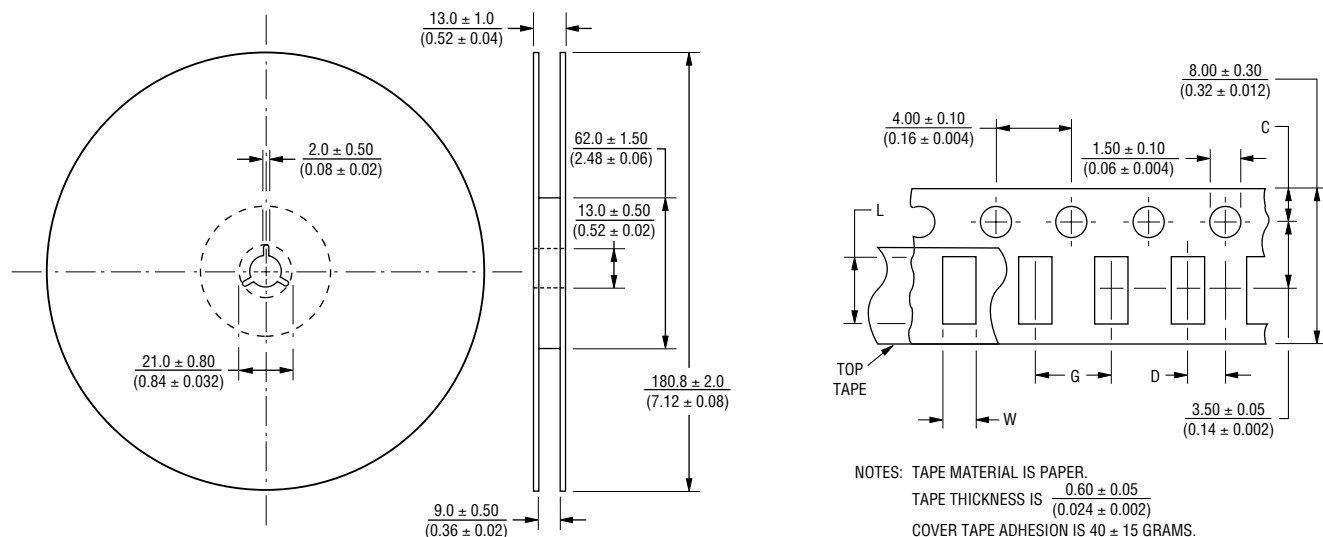
A	Stage 1 Preheat	Ambient to Preheating Temperature	30 s to 60 s
B	Stage 2 Preheat	140 °C to 160 °C	60 s to 120 s
C	Stage 3 Preheat	Preheat to 200 °C	20 s to 40 s
D	Main Heating	200 °C 210 °C 220 °C 230 °C 240 °C	60 s to 70 s 55 s to 65 s 50 s to 60 s 40 s to 50 s 30 s to 40 s
E	Cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

- ⚠ This product can be damaged by rapid heating, cooling or localized heating.
- Heat shocks should be avoided. Preheating and gradual cooling recommended.
 - Excessive solder can damage the device. Print solder thickness of 150 to 200 um recommended.
 - Solder gun tip temperature should be kept below 280 °C and should not touch the device directly. Contact should be less than 3 seconds. A solder gun under 30 watts is recommended.

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Packaging Dimensions



How to Order

CG 0402 MLC - 12 L G A

ChipGuard®
Product Designator
Package Option
0402 = 0402 Package
0603 = 0603 Package
Multilayer Series Designator
Operating Voltage
3.3 = 3.3 V
05 = 5 V
12 = 12 V
Low Leakage Current Option
L = Low Leakage Current
Blank = Standard Product
Tape & Reel Packaging
E = 5,000 pcs. per reel (0603 Package)
G = 10,000 pcs. per reel (0402 Package)
Operating Temperature Option
A = Higher +125 °C Operating Temperature
Blank = Standard Product

Dimension	CG0402 Series	CG0603 Series
C	$\frac{1.75 \pm 0.05}{(0.04 \pm 0.002)}$	$\frac{1.75 \pm 0.10}{(0.04 \pm 0.004)}$
D	$\frac{2.00 \pm 0.02}{(0.08 \pm 0.0008)}$	$\frac{2.00 \pm 0.05}{(0.08 \pm 0.002)}$
L	$\frac{1.12 \pm 0.03}{(0.045 \pm 0.0012)}$	$\frac{1.80 \pm 0.20}{(0.072 \pm 0.008)}$
W	$\frac{0.62 \pm 0.03}{(0.025 \pm 0.0012)}$	$\frac{0.90 \pm 0.20}{(0.036 \pm 0.008)}$
G	$\frac{2.0 \pm 0.05}{(0.08 \pm 0.002)}$	$\frac{4.0 \pm 0.05}{(0.16 \pm 0.002)}$



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